



CURRENT STATUS OF SILICON STUDIES WITH $\text{Ge}_x\text{Si}_{1-x}$ BINARY COMPOUNDS AND POSSIBILITIES OF THEIR APPLICATIONS IN ELECTRONICS[†]

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The paper determines the technological regimes for obtaining $\text{Ge}_x\text{Si}_{1-x}$ alloys by introducing germanium atoms into single-crystal silicon by the diffusion method. From the results of the study, it was found that the fundamental parameters of the formed $\text{Ge}_x\text{Si}_{1-x}$ alloys differ from the fundamental parameters of the original silicon, in particular, the energy values of the silicon band gap change. Elemental analysis of the surface of the samples showed that the concentration of silicon (in atomic percent) was ~70.66%, germanium ~29.36%. It was assumed that on the silicon surface and in the front part, a thin layer of an alloy of a compound with a composition of approximately $\text{Ge}_{0.3}\text{Si}_{0.7}$ ($0.5 \div 2 \mu\text{m}$) would be formed. Analysis of the spectra (p shows that the spectrum contains peaks ~303 cm^{-1} and ~406 cm^{-1} , corresponding to the Ge-Ge and Si-Ge bonds, respectively). It was also shown that $\text{Ge}_x\text{Si}_{1-x}$ binary compounds are a new material for modern electronics, the possibility of creating properties on their basis in electronics was shown. It is proposed on their basis to create devices with new functionality and highly efficient solar cells.

Keywords: Diffusion; Germanium; Silicon; Solubility; Concentration; Binary complexes

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INTRODUCTION

Today, special attention is paid to obtaining new materials with clusters of impurity atoms on the surface and in the bulk of a semiconductor, which is one of the main directions in the development of technology and physics of semiconductor materials [1–3]. In this case, one of the important tasks is the creation of a simple and cheap technology for the formation of clusters (clusters) of impurity atoms in the bulk of a crystal, which makes it possible to create nanoscale structures that change the properties of the base material. The methods of molecular beam epitaxy used to obtain such nanosized structures require expensive equipment.

Obtaining clusters of germanium (quantum dots) in a silicon lattice allows you to significantly expand the spectral region of sensitivity of photodetectors, solar cells. Germanium nanostructures in a solid solution of the $\text{Ge}_x\text{Si}_{1-x}$ type can be obtained on the basis of single-crystal silicon by the diffusion method. It is known [4] that germanium forms stable solid solutions in silicon up to a germanium concentration of 1650 K from 80%. At the same time, the maximum solubility of germanium in silicon reaches $1 \cdot 10^{22} \text{ at/cm}^{-3}$ at a temperature of 1430°C [5].

Upon cooling, the solid solution of germanium in silicon decomposes, and an excess of germanium forms accumulations (clusters) containing mainly germanium (the solubility of silicon in germanium at a temperature of 1550 K is less than 50% [6]).

In this regard, the purpose of research is the development of a diffusion technology for obtaining germanium clusters in the volume of a silicon lattice and the study of the electrical parameters of these materials.

TECHNIQUE AND EXPERIMENTAL

Single-crystal p- and n-type silicon with resistivity of 10 and 100 $\text{Ohm} \cdot \text{cm}$ was chosen as the starting material. The size of all silicon samples was the same $8 \times 4 \times 1 \text{ mm}^3$.

The diffusion technology for obtaining $\text{Ge}_x\text{Si}_{1-x}$ solid solutions with different ratios of components, although of great interest, is technologically unacceptable. This is mainly due to the very small diffusion coefficient of germanium atoms in silicon ($D_0 \sim 10^{-14} \text{ cm}^2/\text{s}$) [7], which requires a long diffusion time (Table 1) to obtain layers with a high concentration of germanium. Here x is the depth at which the concentration of germanium drops by a factor of e , the diffusion time is 20 hours.

We managed to solve the problem of a low diffusion coefficient due to the technology of low-temperature diffusion alloying of silicon with germanium. The technology of two-stage diffusion was used, which makes it possible to obtain a noticeable increase in diffusion coefficients [8–10]. Initial samples of silicon and diffusant - powdered germanium grade GES-1 were placed in quartz ampoules, after which evacuation was performed (residual pressure in the ampule $p \sim 10^{-5} \text{ mm Hg}$). The ampoules were placed in a diffusion furnace of the Vacuum Tube Furnace 1700°C brand at $T = 300\text{K}$.

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and, consequently, mechanical stresses in the samples. To test this assumption, the samples were annealed at a temperature of 1050 °C degrees for 5 hours. Figure 5 shows the Raman spectrum of this sample. There is no Si-Ge peak in the spectrum, and the Ge-Ge peak is noticeably narrower and higher. This indicates the decomposition of the solid solution with the formation of a new germanium phase containing an insignificant amount of silicon.

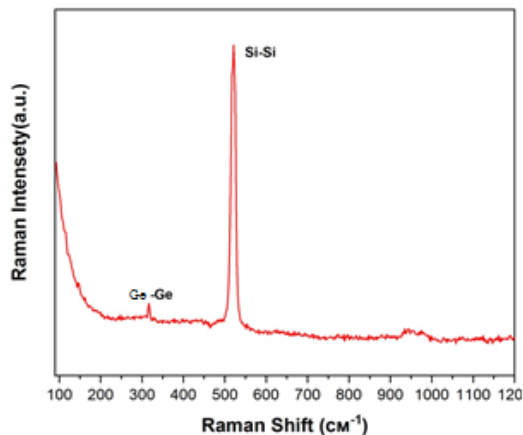


Figure 5. Raman spectrum of the annealed sample.

Figure 6 (a,b) shows the diffraction spectra obtained with a step of 0.05° at a scanning speed of 2°/min in the range of scanning angles of 10°-70°.

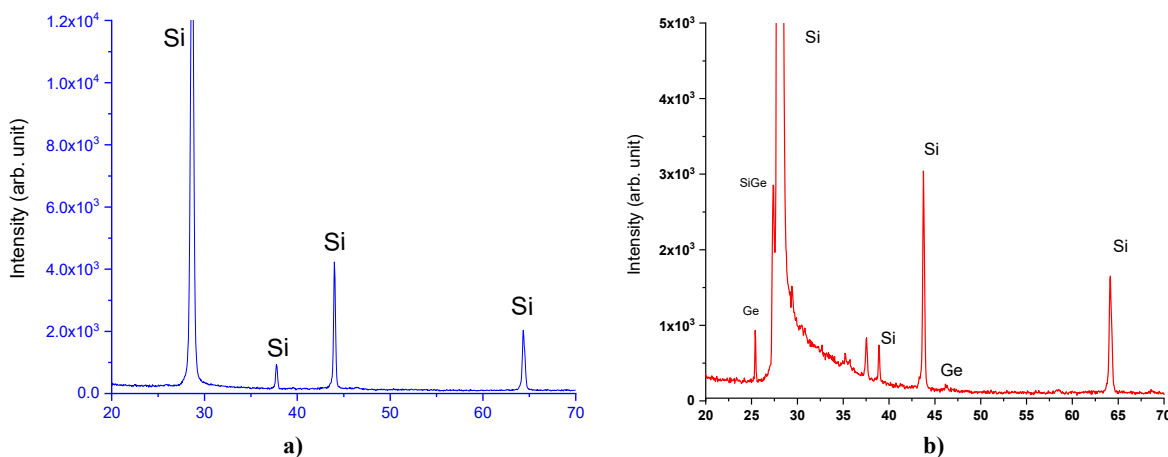


Figure 6. X-ray diffraction pattern: a) initial silicon [18]; b) silicon doped with germanium (no.3)

The diffraction spectra confirm the formation of germanium clusters during the diffusion treatment and the presence of inhomogeneities in the lattice parameter

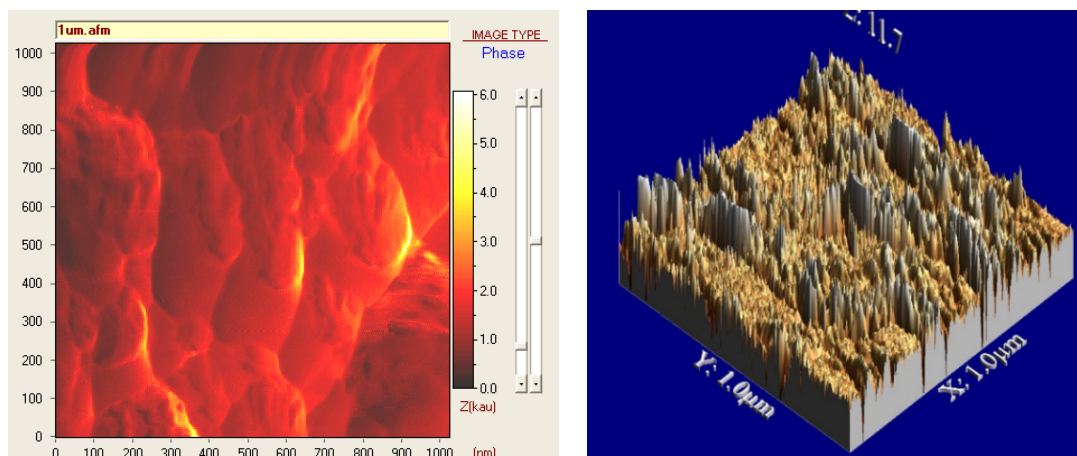


Figure 7. AFM images of the silicon surface doped with impurity germanium atoms

As can be seen from Figure 7, the formation of islands on the silicon surface doped with germanium impurity atoms leads to an increase in the average roughness size. This indicates the formation on the silicon surface of binary compounds $\text{Ge}_x\text{Si}_{1-x}$, the electric potential of which is higher than that of the initial silicon

An analysis of the experimental results showed the formation of binary compounds of the $\text{Ge}_x\text{Si}_{1-x}$ type in the lattice of single-crystal silicon.

Studies of the state of germanium atoms in diffusion-doped silicon according to the developed technology showed that under diffusion conditions a solid mixture of the $\text{Ge}_x\text{Si}_{1-x}$ type is formed in silicon [19-21]. It has been established that germanium impurity atoms in the silicon lattice create monoclusters with a certain composition in the formed binary cell.

CONCLUSION

From the analysis of the spectra obtained by the Raman spectrometer and X-ray diffraction analysis, it can be said that binary silicon-germanium ($\text{Ge}_x\text{Si}_{1-x}$) compounds are formed in the silicon crystal lattice, the concentration of which will increase from the diffusion conditions and heat treatment (temperatures, time). Comparison of the results obtained with the available literature data established that binary compounds of the $\text{Ge}_x\text{Si}_{1-x}$ type are formed in the lattices of single-crystal silicon. In addition, the results obtained show that silicon atoms enriched with germanium atoms lead to a change in the fundamental parameters of the initial silicon. Changing the fundamental parameters of the original silicon allows you to control the electrical, photoelectric and optical parameters of silicon, which makes it possible to obtain a new material with unique photoelectric and optical properties.

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ПОТОЧНИЙ СТАН ДОСЛІДЖЕНЬ КРЕМНІЮ З БІНАРНИМИ СПОЛУКАМИ $\text{Ge}_x\text{Si}_{1-x}$ ТА МОЖЛИВОСТІ ЇХ ЗАСТОСУВАННЯ В ЕЛЕКТРОНІЦІ**Нурулла Ф. Зікріллаєв, Гійосіддін А. углі Кушієв, Сергій В. Ковешніков, Бахромджон А. Абдурахманов,
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Визначено технологічні режими отримання сплавів $\text{Ge}_x\text{Si}_{1-x}$ шляхом введення атомів германію в монокристалічний кремній дифузійним методом. За результатами дослідження встановлено, що фундаментальні параметри сформованих сплавів $\text{Ge}_x\text{Si}_{1-x}$ відрізняються від фундаментальних параметрів вихідного кремнію, зокрема змінюються енергетичні значення ширини забороненої зони кремнію. Елементний аналіз поверхні зразків показав, що концентрація кремнію (в атомних відсотках) становила $\sim 70,66\%$, германію $\sim 29,36\%$. Передбачалося, що на поверхні кремнію і в лицьовій частині утворюється тонкий шар сплаву сполуки складу приблизно $\text{Ge}_{0,3}\text{Si}_{0,7}$ ($0,5 \div 2$ мкм). Аналіз спектрів (ρ) показує, що спектр містить піки $\sim 303 \text{ cm}^{-1}$ and $\sim 406 \text{ cm}^{-1}$, що відповідають зв'язкам Ge-Ge і Si-Ge відповідно. Також було показано, що бінарні сполуки $\text{Ge}_x\text{Si}_{1-x}$ є нових матеріалів для сучасної електроніки, показано можливість створення на їх основі властивостей в електроніці, на їх основі запропоновано створювати прилади з новою функціональністю та високоефективними сонячними елементами.

Ключові слова: дифузія; германій; кремній; розчинність; концентрація; бінарні комплекси